

# **AIDA INRNE, Sofia, Bulgaria**

## **Radiation Sensors for GIF+**

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**Group members:**

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### **Working Program – part of WP 8.5.3**

<b>1. Assembling at INRNE and test with local Cs-137 source of 1 radiation sensor with an electronics and PC based acquisition.</b>	<b>M1 – M18</b>	<b>1 Detector with electronics and PC based acquisition</b>
<b>2. Test and calibration at CERN Gif</b>	<b>M6 – M18</b>	<b>Report</b>
<b>3. Assembling at INRNE – Sofia of 8-10 sensors for Gif++</b>	<b>M12 – M36</b>	<b>8-10 radiation sensors in 3 control modules + microcontroller and CANBUS communication with DAQ</b>
<b>4. Installation and commissioning of the radiation sensors at DAQ of the Gif++</b>	<b>M12 – M48</b>	<b>Report</b>

# Radiation Sensors for GIF++ (Project)

## GIF++ Location: SPS North Area, H4 Beam Line

The intensity of the source will be about **10 TBq** providing up to **2 Gy/h** at a distance of **50 cm**.

The ~10 times higher outcoming uniform photon flux than in the previous GIF corresponds to the expected step in intensity while moving to sLHC conditions.

The Cesium source of GIF++ should provide uniform gamma irradiation on a vertical surface of **7,5 m wide** by **4 m high** at a **distance** of **5m** through the front of the irradiator.

A secondary collimator located in the opposite direction should provide a spherically noncorrected spot of 2,6 m at a distance of 7 m.

Ceiling clearance will be 4 m everywhere inside the bunker.

A **second irradiation beam will be available at 180 degrees** to the main photon beam axis.

This area shall be defined by a separate collimator that allows irradiation of detectors with a **higher flux but over a smaller area**. It shall be possible to activate or isolate the second irradiation beam using a separate shutter.

Max. expected doses at sLHC	Equivalent time at GIF++ (~ 50 cm from source)
Si-trackers: ~ MGy/y	>> years
Calorimeters: ~ 20 kGy/y	< 1 year
Muon systems: ~ 0.1 Gy/y	~ minutes

# Radiation Sensors for the LHC experiments

The sensors for the LHC experiments at CERN are of two types:

- **Thick-Oxide RadFETs** (manufactured by CNRS-LAAS, France):
  - Range up to 10 Gy ( $\Delta V < 10$  V);
  - Initial sensitivity of 500 mV/Gy (5mV/rad);
  - Readout current of 100  $\mu$ A injected over 1 sec;
  - Initial  $V_{th} \sim 2.5$  V;
  - Accuracy of  $\pm 10\%$ .
- **Thin-Oxide RadFETs** (produced by REM, UK):
  - Range up to 20 kGy [ $0.25 \mu\text{m}$ ] and 200 kGy [ $0.13 \mu\text{m}$ ]<sup>2</sup> at  $\Delta V = 25$  V;
  - Initial sensitivity of 20 mV/Gy (0.2 mV/rad) [ $0.25 \mu\text{m}$ ] and 10 mV/Gy (0.1 mV/rad) [ $0.13 \mu\text{m}$ ];
  - Readout current of 160  $\mu$ A injected over 5 sec;
  - Initial  $V_{th} \sim 3$  V;
  - Accuracy of  $\pm 10\%$ .

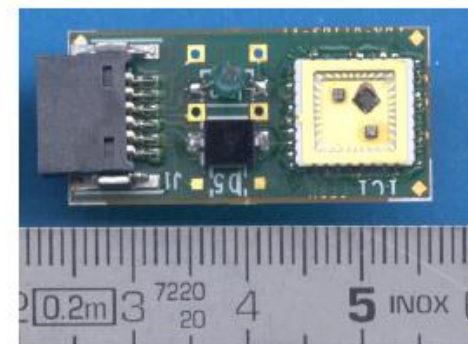
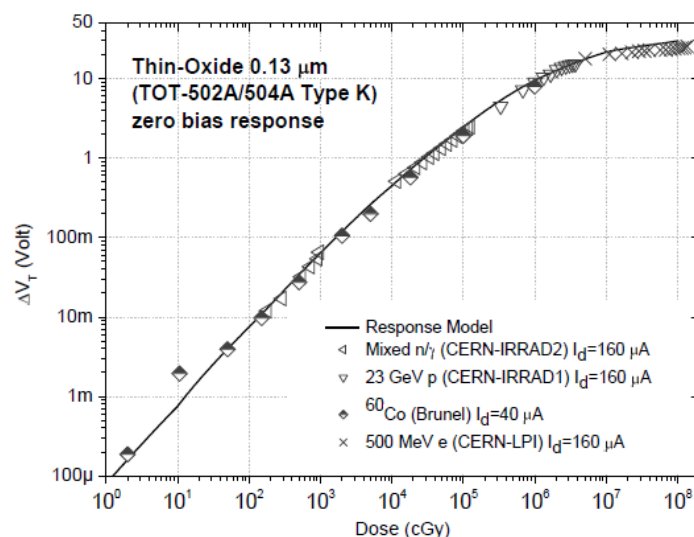
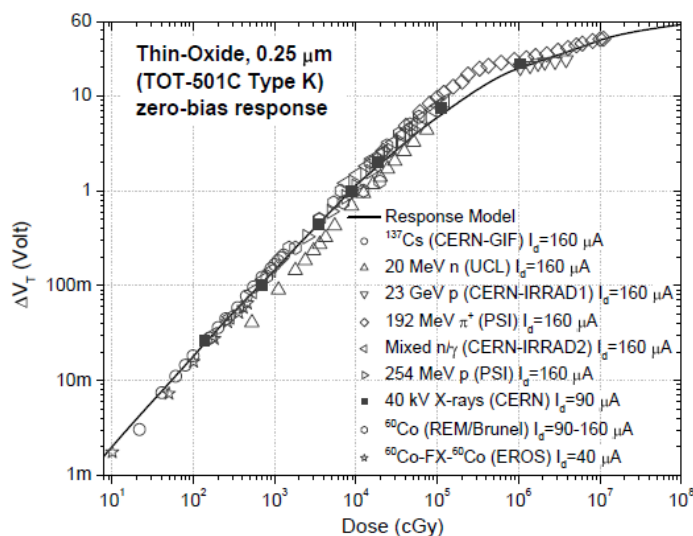
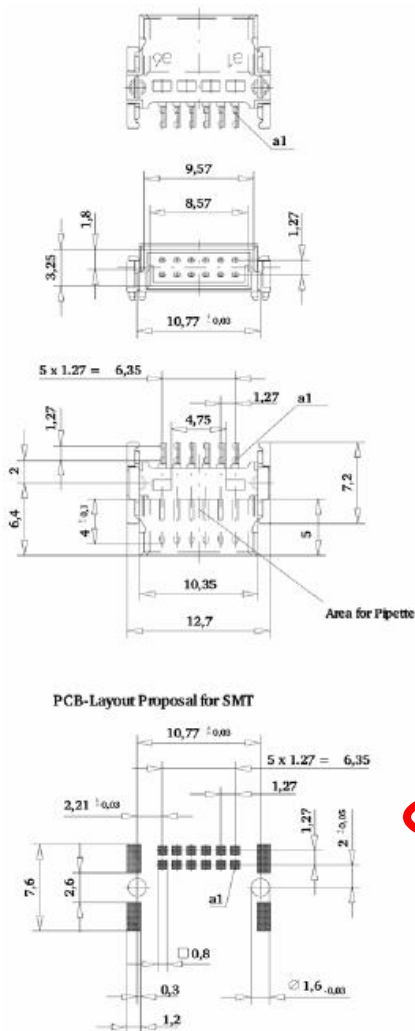


Fig. 3: Integrated Sensor Carrier (ISC)



# INTEGRATED SENSOR PCB

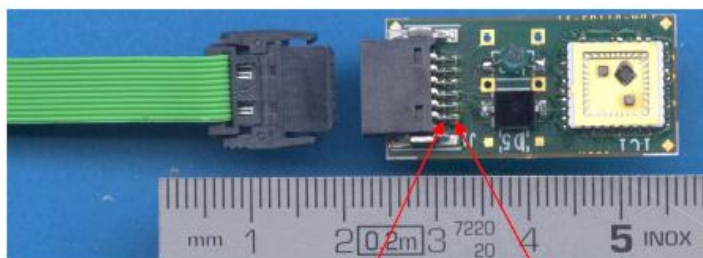
## Connections Layout



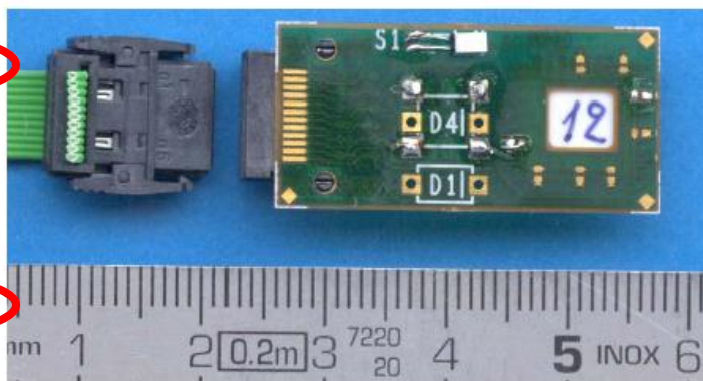
pin-out ERNI  
Male Connector  
SMC-B 12 contacts  
(model: 054594)

ERNI	PCB	Device
a1	gnd	
a2	D5	pin diode
a3	D3	pin diode
a4	D4	pin diode
a5	D1	pin diode
a6	IC1	C3 (REM)
b1	S1	I. probe
b2	IC1	C4 (LAAS)
b3	n.c.	free
b4	D2	pin diode
b5	IC1	C1 (REM)
b6	IC1	C2 (LAAS)

FRONT



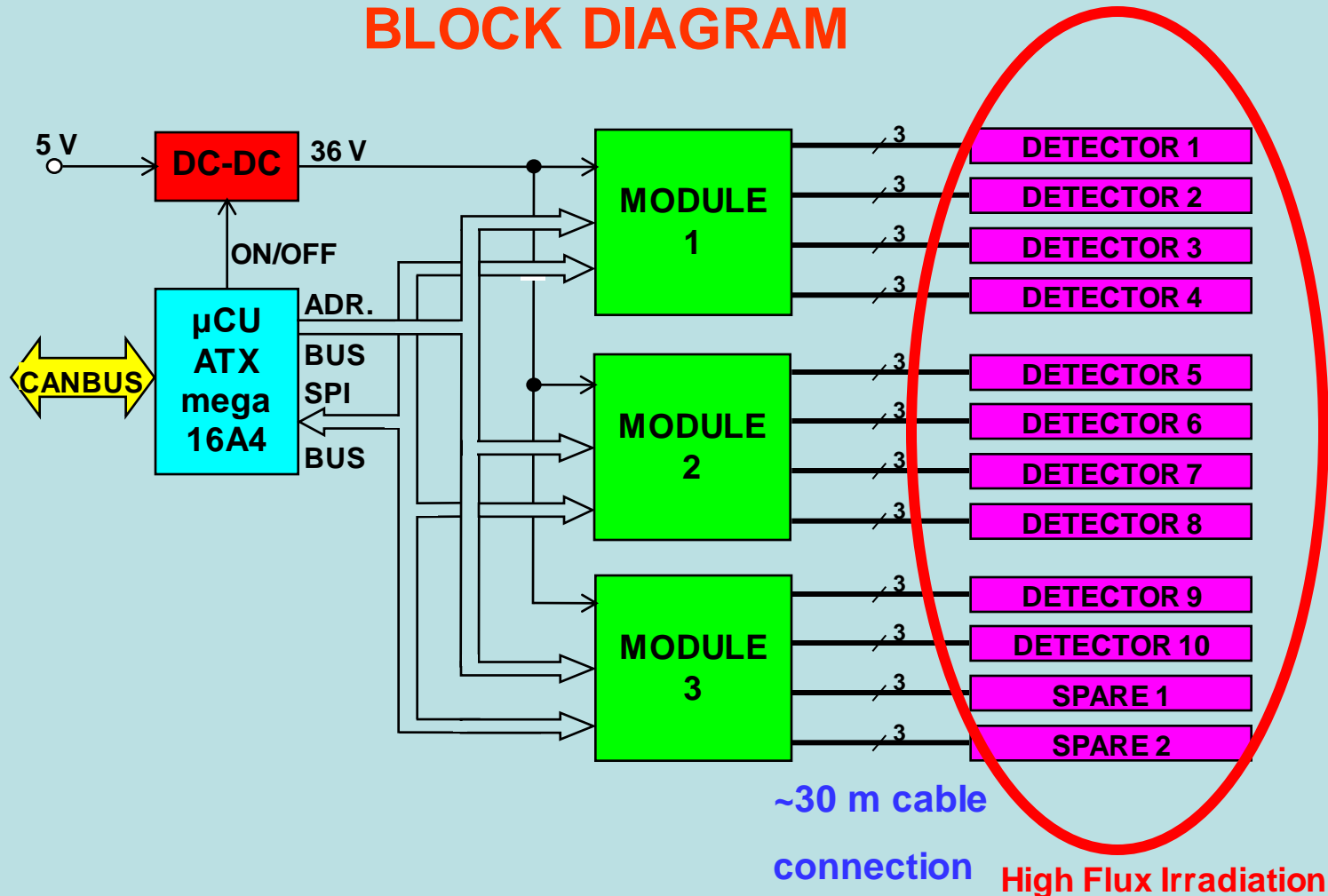
BACK



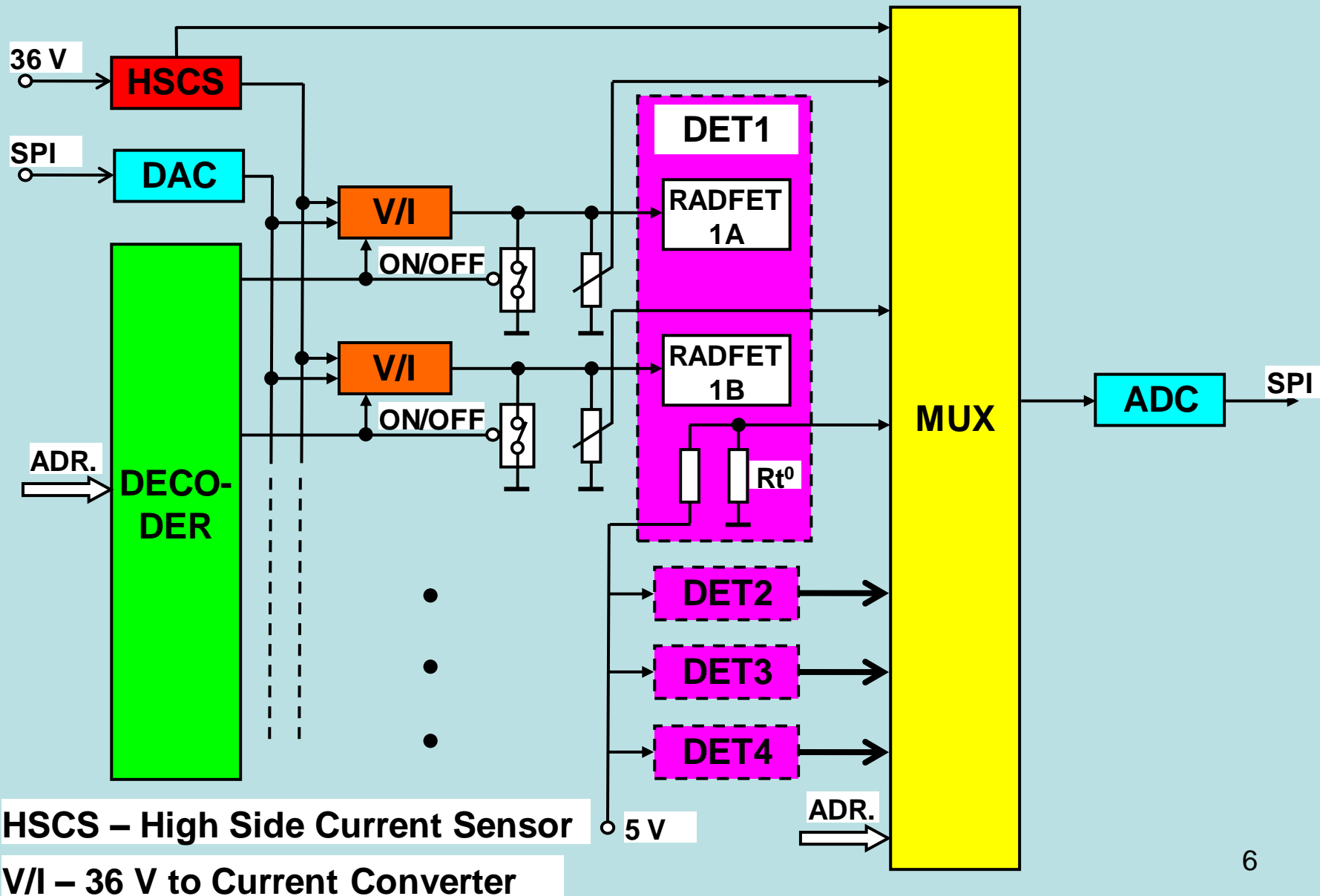
NOTE: Devices to be supplied with negative currents !

F.Ravotti, M.Glaser (72058)  
CERN - August 2006

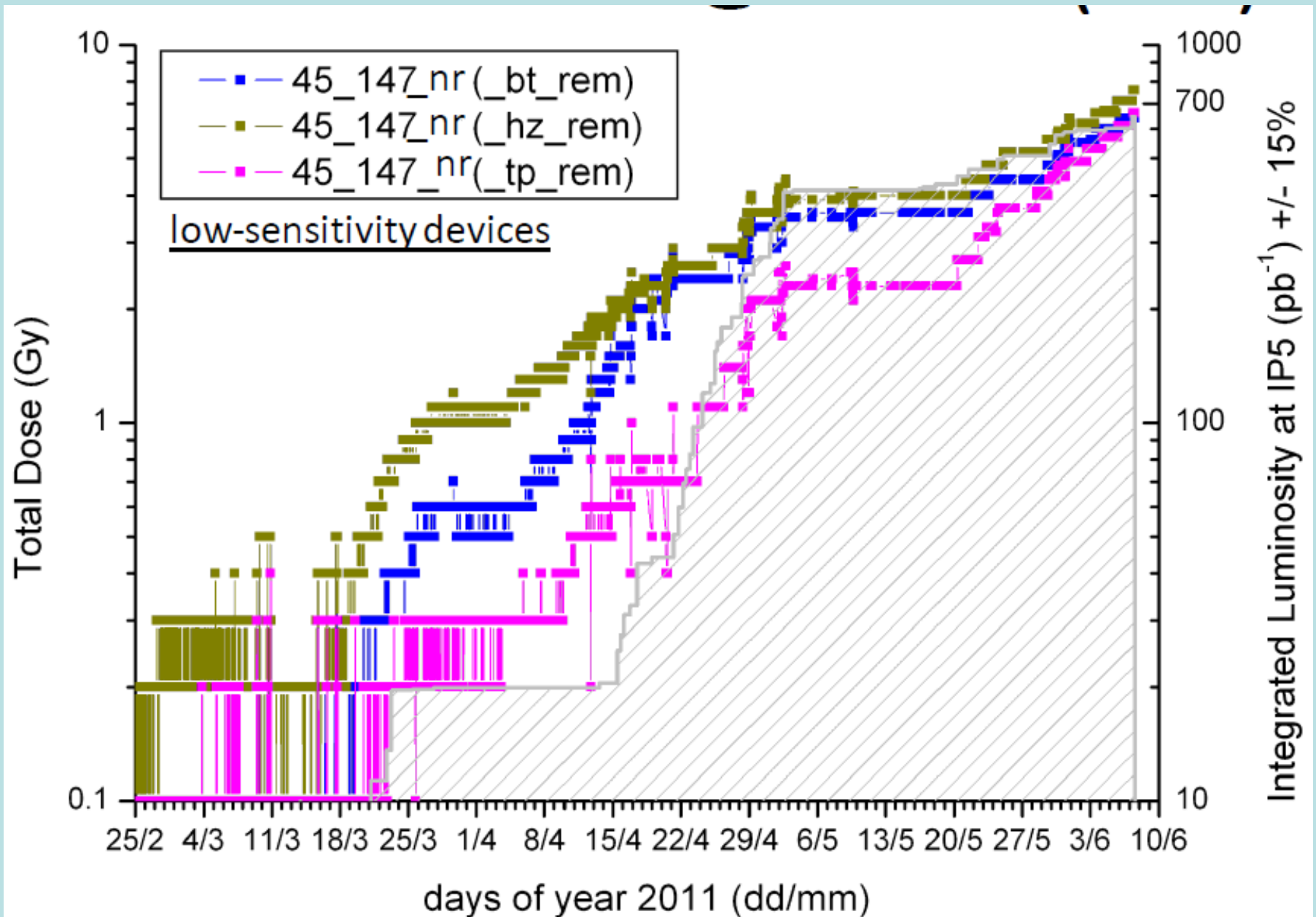
# RADIATION SENSORS BLOCK DIAGRAM



# MODULE BLOCK DIAGRAM



BACKUP SLIDES





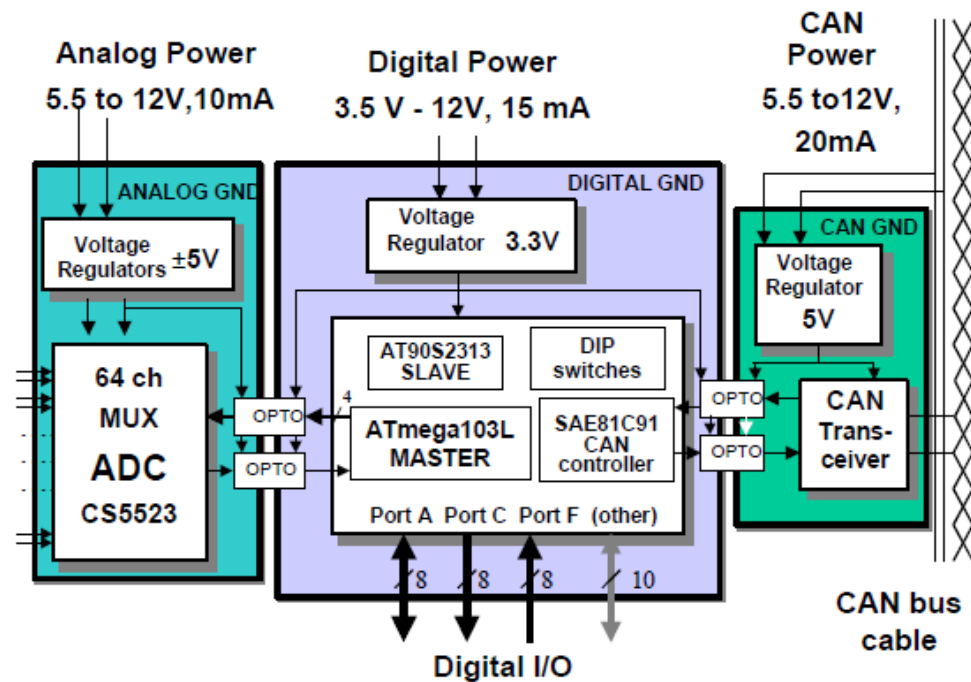


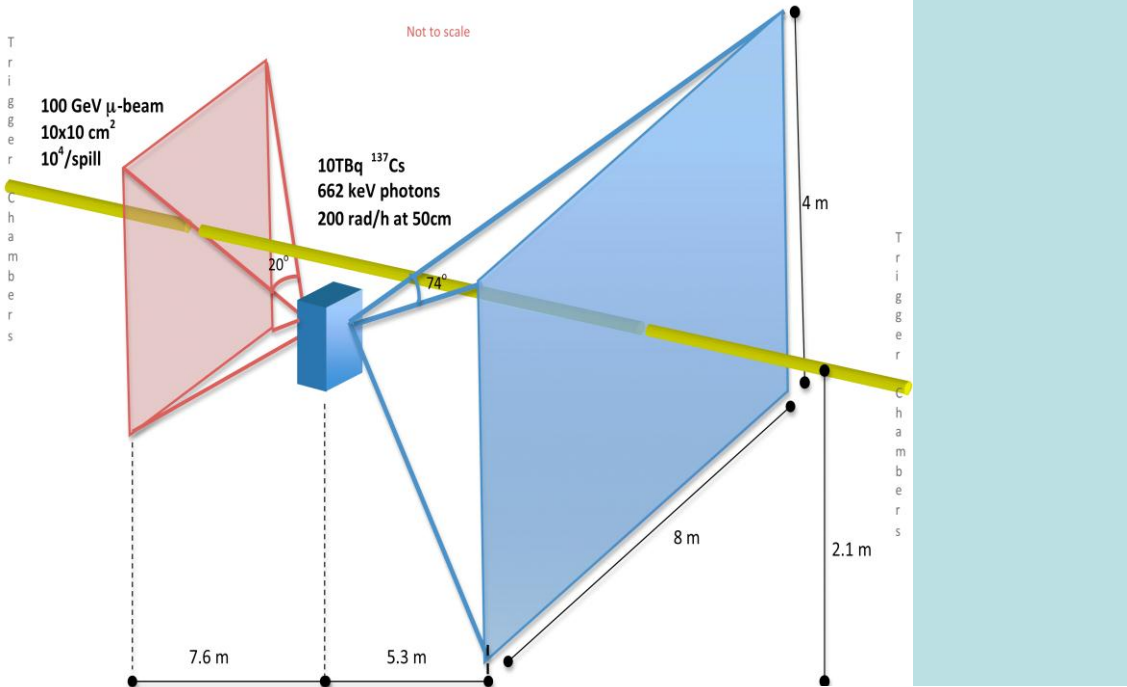
Figure 1: Simplified block diagram of the ELMB module



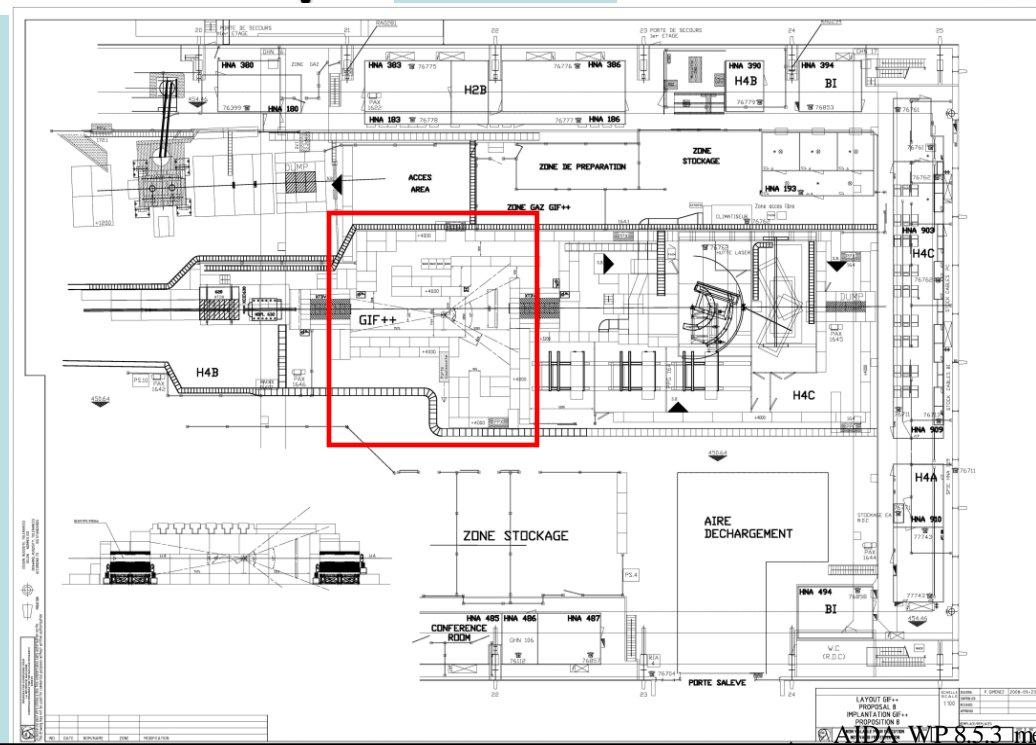
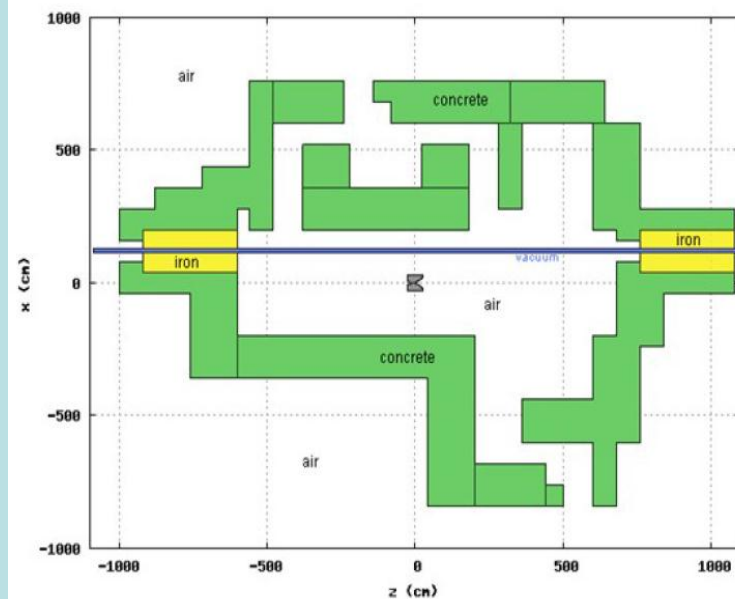
Figure 3: The front side of the ELMB



Figure 2: The back side of the ELMB module



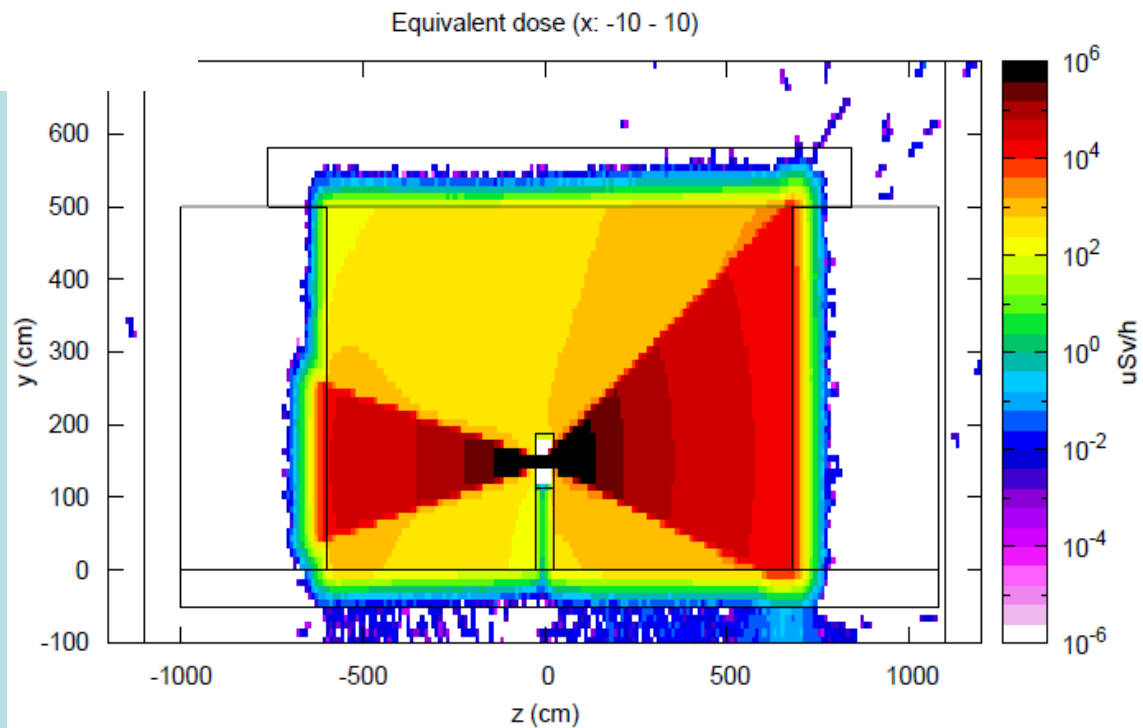
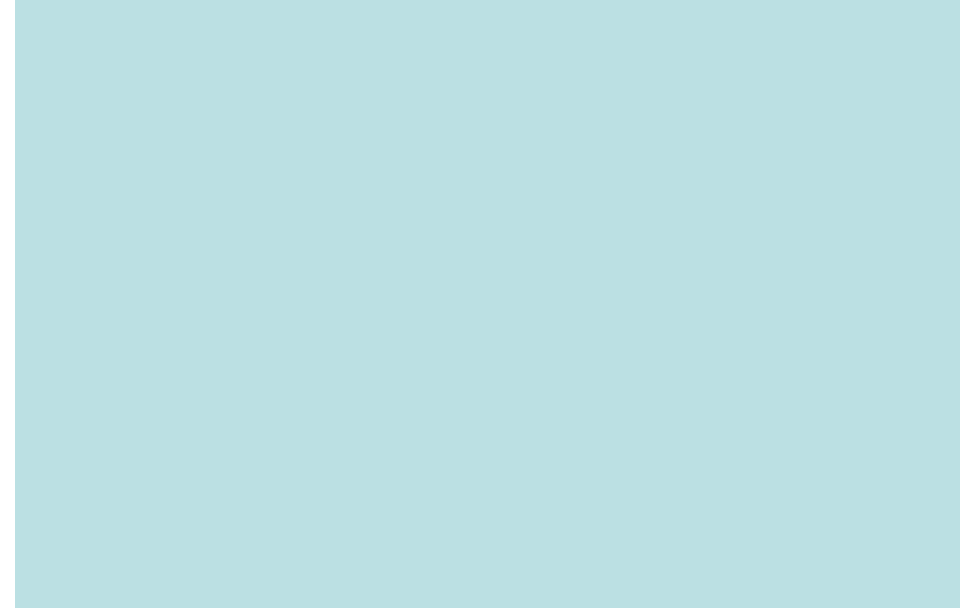
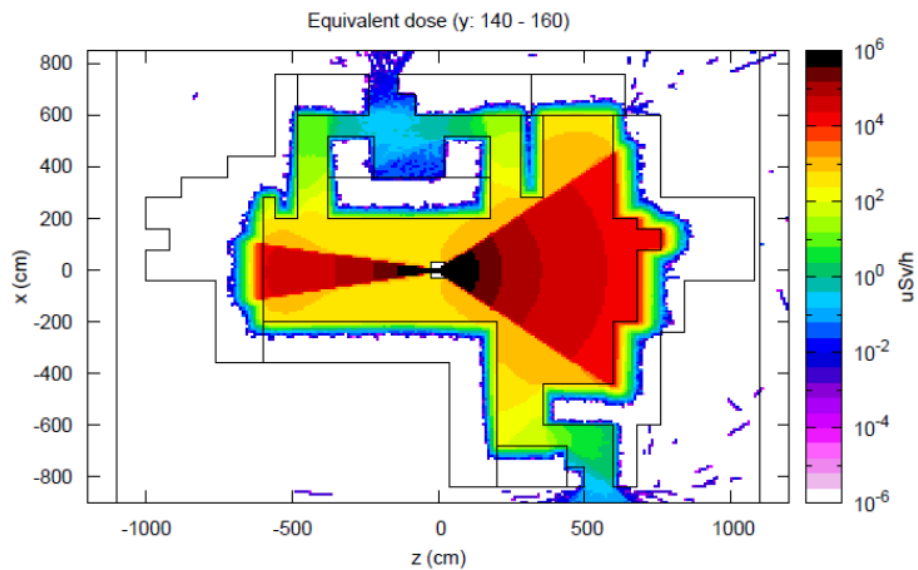
## GIF++ Geometry



Control system, a total of **7-wires (6 to the DCS + 1 reference)** must be available in the counting room for the full readout of the elements of the ISC. The detailed connectivity of this ISC configuration is shown in Table 1.

<b>RPMB PAD</b>	<b>BURNDY RPMB</b>	<b>ERNI RADMON</b>	<b>PCB Serigraphy</b>	<b>Back-Board Connection</b>	<b>TOTEM Device</b>
B10	1	B6	IC1-C2	12	LAAS
B11	—	B5	IC1-C1	10	—
B12	2	B4	D2	8	CMRP
B13	—	B3	IC1-36	6	—
B14	3	B2	IC1-C4	4	REM250
B15	—	B1	S1	2	—
B16	—	A6	IC1-C3	11	—
B17	4	A5	D1	9	RESIS1K
B18	5	A4	D4	7	SPARE3
B19	6	A3	D3	5	BPW34
B20	7	A2	D5	3	NTC
B21	8	A1	GND	1	RGND

Table 1: Connectivity table of the RADMON ISC in "Redundancy" configuration for TOTEM.

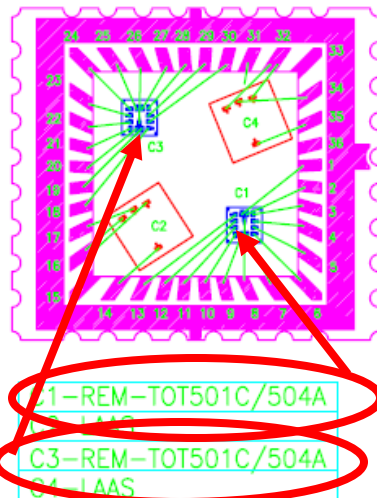


12

Max. expected doses at SLHC	Equivalent time at GIF++ (~ 50 cm from source)
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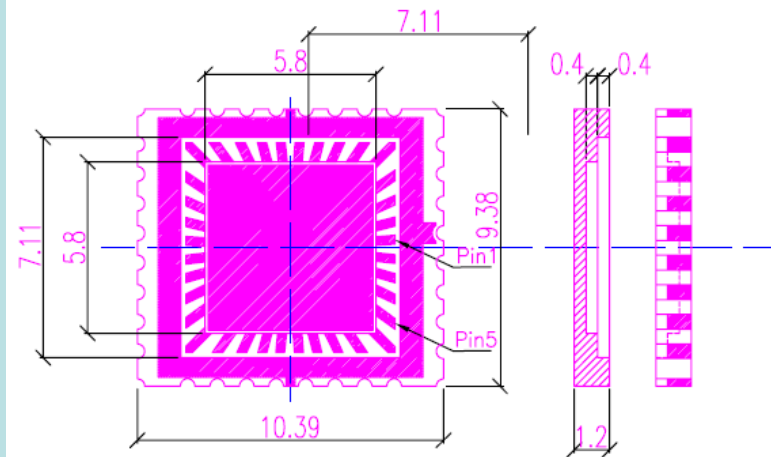
## Part bounding (Model 0)

01-C1-D3-K	19-C3-D3-K
02-C1-S2-K	20-C3-S2-K
03-C1-G2-K	21-C3-G2-K
04-C1-D2-K	22-C3-D2-K
05-C1-S1-R	23-C3-S1-R
06-C1-G1-R	24-C3-G1-R
07-C1-D1-R	25-C3-D1-R
08-C1-BULK	26-C3-BULK
09-C1-S4-R	27-C3-S4-R
10-C1-G4-R	28-C3-G4-R
11-C1-D4-R	29-C3-D4-R
12-C1-S3-K	30-C3-S3-K
13-C1-G3-K	31-C2C4-BULK
14-C2-S	32-C4-G
15-FREE	33-FREE
16-C2-G	34-C4-D
17-C2-D	35-C4-S
18-C3-G3-K	36-FREE



## Part Dimensions

36 pin square Ceramic Chip Carrier  
MIL-STD-105 D



## Land pattern LDCC36 (Model 0)

